onsemi

<u>Silicon Carbide (SiC)</u> <u>Schottky Diode</u> – EliteSiC, 20 A, 1200 V, D3, TO-247-3L

NDSH20120CDN

Description

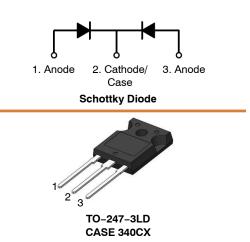
Silicon Carbide (SiC) Schottky Diodes use a completely new technology that provides superior switching performance and higher reliability compared to Silicon. No reverse recovery current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next generation of power semiconductor. System benefits include highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size and cost.

Features

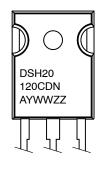
- Max Junction Temperature 175°C
- Avalanche Rated 49 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery / No Forward Recovery
- This Device is Halide Free and RoHS Compliant with Exemption 7a, Pb–Free 2LI (on second level interconnection)

Applications

- General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuits



MARKING DIAGRAM



| A = / YWW = I | Specific Device Code Assembly Plant Code Date Code (Year & Week) Lot Code |
|------------------|--|
|------------------|--|

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

NDSH20120CDN

| ABSOLUTE | MAXIMUM RATINGS (T _J = $25^{\circ}C$ unless otherw | vise noted) (per leg) | | |
|-----------------------------------|--|--|-------------|----|
| Symbol | Parameter | Value | Unit | |
| V _{RRM} | Peak Repetitive Reverse Voltage | 1200 | V | |
| E _{AS} | Single Pulse Avalanche Energy (Note 1) | 49 | mJ | |
| ١ _F | I _F Continuous Rectified Forward Current @ T _C < 145°C | | 10*/20** | A |
| | Continuous Rectified Forward Current @ T_C < | 12*/24** | | |
| I _{F, Max} | Non-Repetitive Peak Forward Surge Current | T _C = 25°C, 10 μs | 546 | A |
| | | T _C = 150°C, 10 μs | 459 | A |
| I _{F,SM} | Non-Repetitive Forward Surge Current | Half-Sine Pulse, t _p = 8.3 ms | 59 | A |
| I _{F,RM} | Repetitive Forward Surge Current | Half-Sine Pulse, t _p = 8.3 ms | 31 | A |
| Ptot | Power Dissipation | $T_{\rm C} = 25^{\circ}{\rm C}$ | 94 | W |
| | | T _C = 150°C | 16 | W |
| T _J , T _{STG} | T _J , T _{STG} Operating and Storage Temperature Range | | –55 to +175 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

*Per leg. ** Per device.

1. EAS of 49 mJ is based on starting T_J = 25°C, L = 0.5 mH, IAS = 14 A, V = 50 V.

THERMAL CHARACTERISTICS (per leg)

| Symbol | Parameter | Value | Unit | |
|---|-----------|-------------|------|--|
| R _{0JC} Thermal Resistance, Junction to Case, Max | | 1.6*/0.65** | °C/W | |
| R _{0JA} Thermal Resistance, Junction to Ambient, Max | | 40 | °C/W | |

*Per leg.

** Per device.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted) (per leg)

| Symbol | Parameter | Test Condition | Min | Тур | Max | Unit |
|----------------|-------------------------|---|-----|------|------|------|
| V _F | Forward Voltage | I _F = 10 A, T _J = 25°C | - | 1.39 | 1.75 | V |
| | | $I_F = 10 \text{ A}, \text{ T}_J = 125^{\circ}\text{C}$ | - | 1.68 | - | |
| | | $I_F = 10 \text{ A}, \text{T}_J = 175^{\circ}\text{C}$ | - | 1.94 | - | |
| I _R | Reverse Current | V_{R} = 1200 V, T_{J} = 25°C | - | 1 | 200 | μΑ |
| | | V_{R} = 1200 V, T_{J} = 125°C | - | 3 | 200 | |
| | | V_{R} = 1200 V, T_{J} = 175°C | - | 8 | 200 | |
| Q _C | Total Capacitive Charge | V = 800 V | - | 46 | - | nC |
| С | Total Capacitance | V _R = 1 V, f = 100 kHz | - | 680 | - | pF |
| | | V _R = 400 V, f = 100 kHz | - | 41 | - | 1 |
| | | V _R = 800 V, f = 100 kHz | - | 32 | - | 1 |

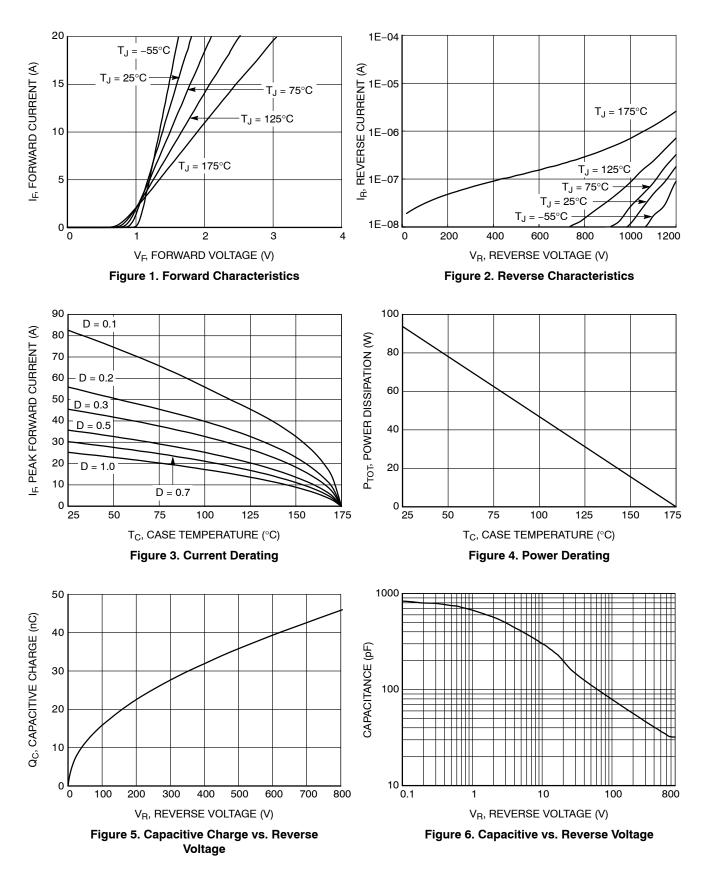
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

| Part Number | Top Marking | Package | Shipping |
|--------------|-------------|--|-----------------|
| NDSH20120CDN | DSH20120CDN | TO-247-3LD (Pb-Free / Halogen Free) | 30 Units / Tube |

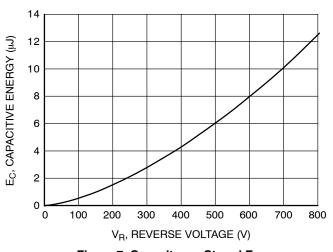
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TYPICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)



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TYPICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)





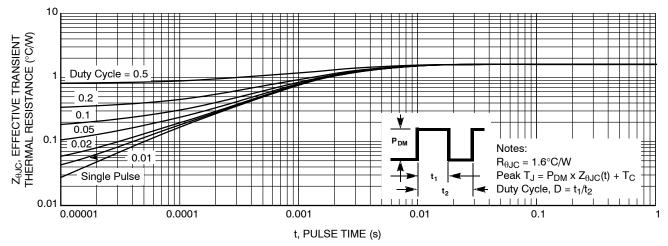
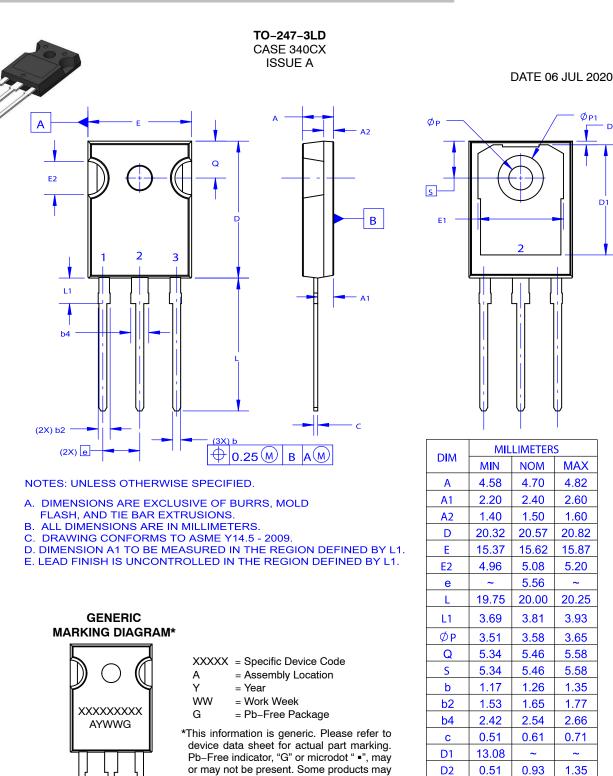


Figure 8. Junction-to-Case Transient Thermal Response Curve



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